

Driver circuit for InGaAs linear image sensor

C11514

Driver circuit for InGaAs linear image sensor (G11135 series, G14006-512DE)

The C11514 is a driver circuit developed for InGaAs linear image sensors (G11135 series, G14006-512DE). The driver circuit consists of an analog video signal processing circuit (16-bit A/D converter), digital control section, interface, and power supply. The circuit converts analog video signals received from an image sensor into digital signals and outputs them. A PC is connected to the circuit through the CameraLink connector (Base Configuration) and used to control the C11514 and retrieve data. The power to the circuit is supplied from the DC jack using the supplied adapter. Further, The C11514 has a BNC connector for external trigger input and a BNC connector for pulse output that can be used to synchronize with external devices.

The C11514 comes with application software (DCam-CL) that runs on Microsoft® Windows® 7 (32-bit, 64-bit) or 10 (32-bit, 64-bit). It can be used to easily operate the C11514 from the PC. The application software includes a C11514 function library (SSDic. DLL) that users can use to develop their own software.

Features

- Built-in 16-bit A/D converter
- **■** Interface: CameraLink
- **■** Supply voltage: Single +5 VDC
- External synchronization function
- Gain and offset adjustment function

- Applications

- → Non-destructive inspection
- Sorting machines
- **G11135** series, G14006-512DE control and data acquisition

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The C11514 is compatible with the following InGaAs linear image sensors (Sensor sold separately).

| Type no. | Total number of pixels | Number of effective pixels | Pixel size [μm (H) × μm (V)] | Pixel pitch (µm) | Image size (mm) |
|--------------|------------------------|----------------------------|---------------------------------|---------------------|--------------------|
| G11135-256DD | 256 | 256 | 50 × 50 | 50 | 12.8 × 0.05 |
| G11135-512DE | 512 | 512 | 25 × 25 | 25 | 12.8 × 0.025 |
| G14006-512DE | 512 | 512 | 25 × 25 | 25 | 12.8 × 0.025 |

- Structure

| Parameter | Specification | Unit |
|----------------|---------------------------------|------|
| Output type | Digital | - |
| A/D resolution | 16 | bit |
| Interface | CameraLink (Base Configuration) | - |

■ Absolute maximum ratings

| Parameter | Symbol | Condition | Value | Unit |
|-------------------------|--------|-----------|------------|------|
| Supply voltage | Vdd | Ta=25 °C | 0 to +6.0 | V |
| Input signal voltage*1 | Vi | Ta=25 °C | 0 to Vdd | V |
| Operating temperature*2 | Topr | | 0 to +50 | °C |
| Storage temperature*2 | Tstg | | -20 to +70 | °C |

^{*1:} Trigger input

When there is a temperature difference between a product and the surrounding area in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

■ Electrical characteristics (Ta=25 °C)

| Parameter | | Symbol | Condition | Min. | Тур. | Max. | Unit | |
|---------------------|------------|--------|--------------|----------|------|-------|------------|---|
| Scan rate*3 | | fop | | - | 5 | - | MHz | |
| | | | G11135-256DD | | | 15723 | | |
| Line rate*4 | | LR | G11135-512DE | - | - | 8710 | lines/s | |
| | | | G14006-512DE | | | 8710 | | |
| Conversion gain | | Gc | Gain 1 | - | 31.6 | - | μV/ADU | |
| | | | Gain 5 | - | 158 | - | | |
| Trigger output | High level | | | Vdd=+5 V | 3.8 | - | Vdd | V |
| voltage Low level | | _ | Vuu=+5 V | - | - | 0.6 | V | |
| Trigger input | High level | | | Vdd=+5 V | 3.5 | - | Vdd | V |
| voltage | Low level | _ | vuu=+5 v | - | - | 1.5 |] v | |
| Current consumption | | I | | - | - | 420 | mA | |

^{*3:} Fixed

➡ Electrical and optical characteristics (Ta=25 °C)

| Parameter | Symbol | Condition | MIn. | Тур. | Max. | Unit |
|---------------------|--------|-----------|------|------|------|------|
| Readout noise*5 | Nr | Gain 1 | - | 15 | - | ADU |
| Reduout noise | | Gain 5 | - | 75 | - | ADU |
| Dynamic range | DR | Gain 1 | - | 3000 | - | |
| Dynamic range | | Gain 5 | - | 600 | - | _ |
| Operating voltage*6 | Vop | | 4.75 | 5 | 5.25 | V |

^{*5:} Integration capacitance: 0.1 pF

Function

| Parameter | | Specification | | |
|---|-------------------------------|--|--|--|
| | Internal synchronization mode | Data is acquired according to the trigger timing from the application software. | | |
| Data acquisition mode | External synchronization mode | The start of integration, integration time, and the number of lines of the acquisition data are controlled by the input pulses to the TRIGGER_IN connector. | | |
| Gain adjustment | | The output ADU can be varied in the range of 1 to 5 times. | | |
| Offset adjustment | | This function adds any value to the output ADU by digital setting which can be varied within a specified range. | | |
| Pulse output setting | | This is used to set the pulse signal to output from the PULSE_OUT connector (output on/off, signal polarity, delay time, pulse width). This signal is output in sync with the start of the integration time of the InGaAs image sensor. The signal output level i H-CMOS compatible. | | |
| Integration capacitance switch function | | This function changes the integration amplifier's capacitance in the InGaAs images sensor. The integration capacitance can be switched between 0.1 pF and 1 pF. The default value is 0.1 pF. For more details, refer to the G11135 series, G14006-512DE datasheets. | | |
| Storage of settings | | Settings for data acquisition and the like can be saved in the circuit's internal memory. | | |

Note: For details on each function, refer to the instruction manual that comes with the product.

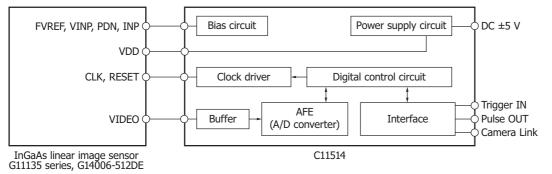


^{*2:} No dew condensation

^{*4:} Theoretical line rate value determined by the internal operation timing of the driver circuit.

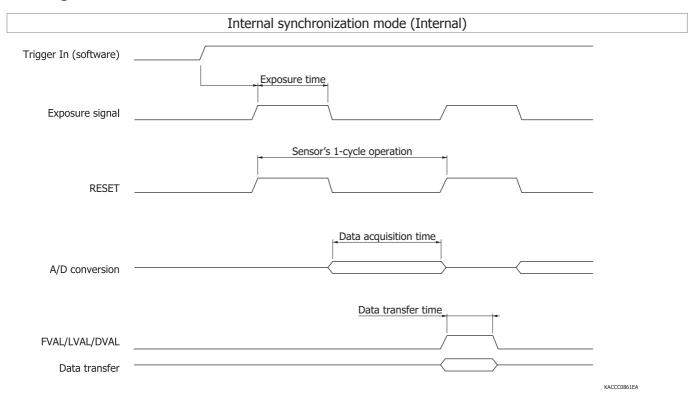
^{*6:} DC power supply

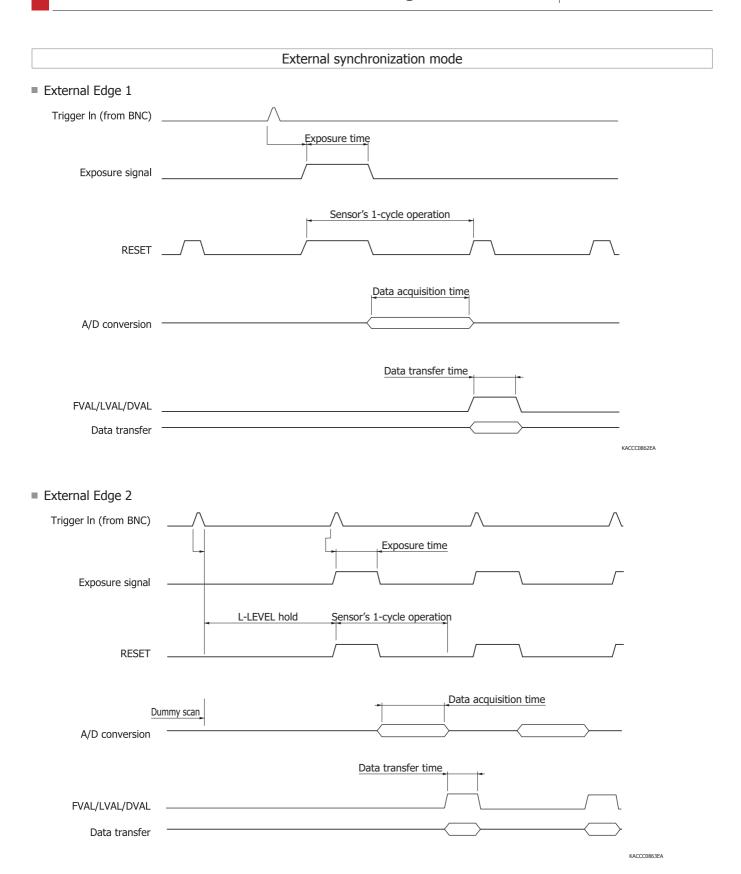
Block diagram



KACCC0868EE

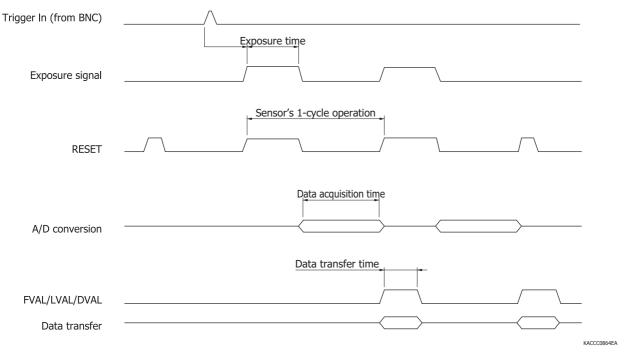
- Timing chart





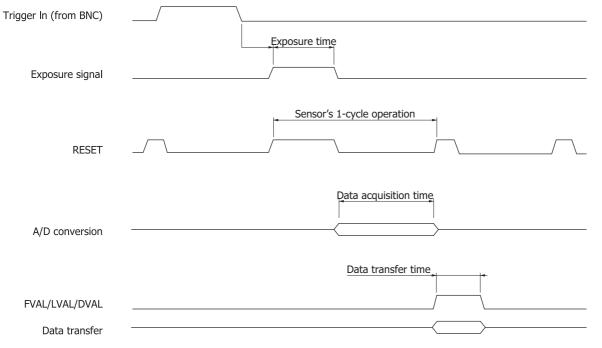


■ External Edge 3*5



*5: When acquiring 2-line data

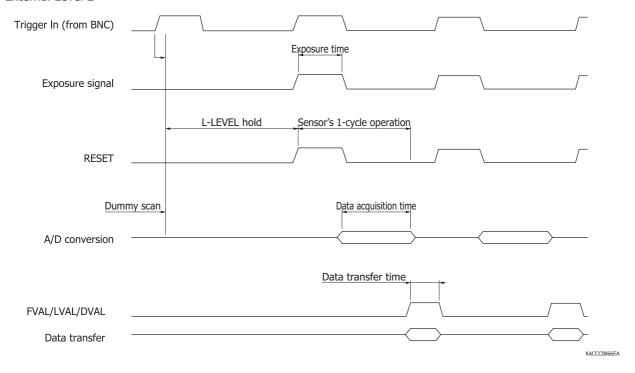
■ External Level 1



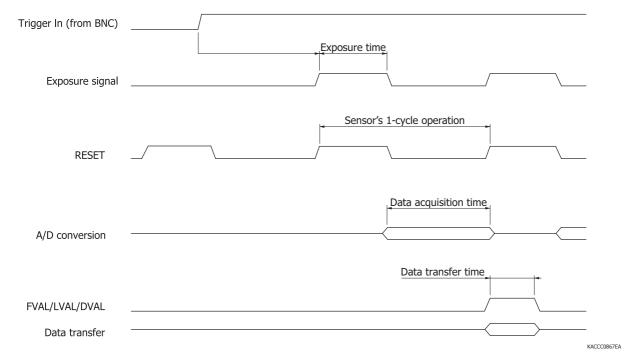
KACCC0865EA



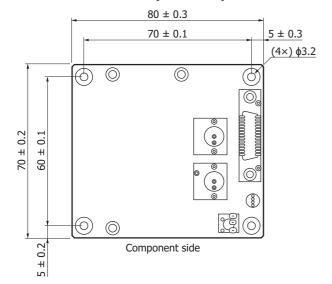
■ External Level 2

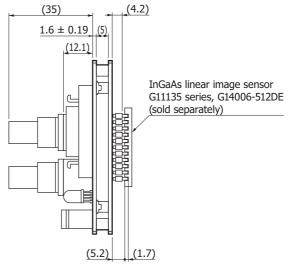


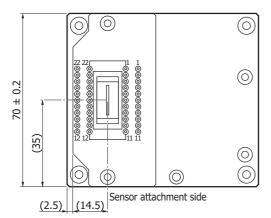
External Gated



Dimensional outline (unit: mm)



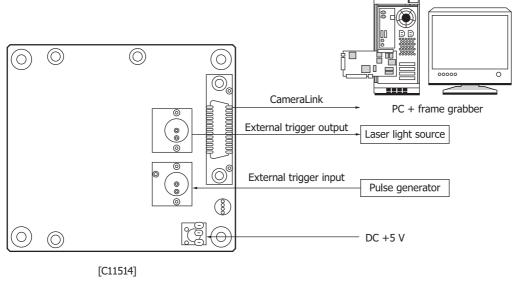




Values in parentheses indicate reference values. Weight: 70 g (excluding the sensor)

KACCA0396EB

- Connection example



KACCC0869EA

Accessories

- · Application software (DCam-CL)
- · Function library (SSDic.dll)
- · AC adapter

NOTE: A National Instruments frame grabber board and NI-IMAQ are required to use the supplied application software (DCam-CL) and function library (SSDic.dll). Operation of the following frame grabber boards has been verified.

| Manufacturer | Model No. | Supported OS | Driver | |
|----------------------|-----------|--|--|--|
| National Instruments | PCIe-1427 | Windows [®] 7 (32-bit, 64-bit), Windows [®] 10 (32-bit, 64-bit) | | |
| | PCIe-1429 | | National Instruments tool (supplied with NI-IMAQ) | |
| | PCIe-1430 | | | |
| | PCIe-1433 | | | |

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

- Precautions
- · Disclaimer

- Compatible product datasheets

Available at our website (www.hamamatsu.com)

 \cdot InGaAs linear image sensor G11135-256DD, G11135-512DE, G14006-512DE



Information described in this material is current as of October 2017.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

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